



SN 09/382,929

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Paul A. Farrar	Examiner:	David Graybill
Serial No.:	09/382,929	Group Art Unit:	2822
Filed:	August 25, 1999	Docket:	303.603US1
Title:	PACKAGING OF ELECTRONIC CHIPS WITH AIR-BRIDGE STRUCTURES		

COMMUNICATION CONCERNING RELATED APPLICATION(S)

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Applicant would like to bring to the Examiner's attention the following related application(s) in the above-identified patent application:

<u>Serial/Patent No.</u>	<u>Filing Date/Issue Date</u>	<u>Attorney Docket</u>	<u>Title</u>
10/930252	August 31, 2004	1303.116US1	INTEGRATED CIRCUIT COOLING AND INSULATING DEVICE AND METHOD
10/929632	August 30, 2004	303.681US2	POLYNORBORNENE FOAM INSULATION FOR INTEGRATED CIRCUITS
10/931510	September 1, 2004	303.603US2	PACKAGING OF ELECTRONIC CHIPS WITH AIR-BRIDGE STRUCTURES
11/001930	December 2, 2004	1303.128US1	INTEGRATED CIRCUIT COOLING SYSTEM AND METHOD

COMMUNICATION CONCERNING RELATED APPLICATIONS

Serial Number: 09/382,929

Filing Date: August 25, 1999

Title: PACKAGING OF ELECTRONIC CHIPS WITH AIR-BRIDGE STRUCTURES

Page 2

Dkt: 303.603US1

Continuations and divisionals may be later filed on the cases listed above, or cited to the Examiner in any previous Communication Concerning Related Applications. Applicants request that the Examiner review all continuations and divisionals of the above-listed or previously-cited patent applications before allowing the claims of the present patent application.

Respectfully submitted,

PAUL A. FARRAR

By Applicant's Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

P.O. Box 2938

Minneapolis, MN 55402

(612) 349-9587

Date

12 Sept 05

By

Timothy B. Clise

Reg. No. 40,957

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 12 day of September, 2005.

Name

Ting Kohout

Signature

Z. L. H.

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

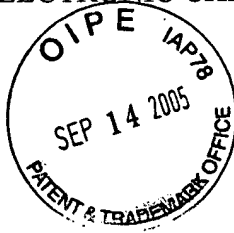
Applicant: Paul A. Farrar

Title: PACKAGING OF ELECTRONIC CHIPS WITH AIR-BRIDGE STRUCTURES

Docket No.: 303.603US1

Filed: August 25, 1999

Examiner: David Graybill



Serial No.: 09/382,929

Due Date: October 11, 2005

Group Art Unit: 2822

MS AF

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

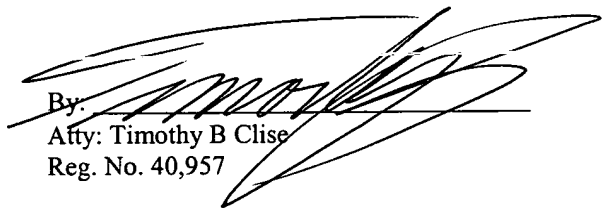
We are transmitting herewith the following attached items (as indicated with an "X"):

- ☒ Return postcard.
- ☒ Amendment and Response (18 pgs.).
- ☒ Communication Concerning Related Applications (2 pgs.).
- ☒ Copies of 1st page of 3 Patents (3 pgs.).

If not provided for in a separate paper filed herewith, Please consider this a **PETITION FOR EXTENSION OF TIME** for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

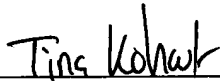
SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

Customer Number 21186

By: 
Atty: Timothy B Clise
Reg. No. 40,957

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 12 day of September, 2005.

Name



Signature



SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

(GENERAL)